

EV-VND7004AY

VND7004AY Evaluation Board

Data brief



Features

| Max transient supply voltage | V _{CC} | 40 V |
|-----------------------------------|-------------------|-----------|
| Operating voltage range | V _{CC} | 4 to 28 V |
| Typ. on-state resistance (per Ch) | R _{ON} | 4 mΩ |
| Current limitation (typ) | I _{LIMH} | 100 A |
| Stand-by current (max) | I _{STBY} | 0.5 µA |

- Simple single IC application board dedicated for VND7004AY
- Provides electrical connectivity and thermal heat-sinking for easy prototyping
- General device features
 - Double channel smart high-side driver with MultiSense analog feedback
 - Very low standby current
 - Compatible with 3 V and 5 V CMOS outputs
- Diagnostic functions

Multiplexed analog feedback of: load current with high precision proportional current mirror, VCC supply voltage and TCHIP device temperature

- Overload and short to ground (power limitation) indication
- Thermal shutdown indication
- OFF-state open-load detection
- Output short to VCC detection
- Sense enable/ disable
- Protections
 - Undervoltage shutdown
 - Overvoltage clamp
 - Load current limitation
 - Self limiting of fast thermal transients
 - Configurable latch-off on overtemperature or power limitation with dedicated fault reset pin
 - Loss of ground and loss of VCC
 - Reverse battery through self turn-on
 - Electrostatic discharge protection

Applications

Specially intended for Automotive Smart Power Distribution, Glow Plug, Heating Systems, DC Motors, Relay replacement and high power resistive and inductive actuators.

Description

This board provides you an easy way to connect ${\sf STMicroelectronics}^{\it {\rm I\!R}}$ VIPower $^{\it {\rm R}}$ M0-7 technology into your existing system.

Table 1. Device summary

| Order Code | Reference |
|--------------|----------------------------|
| EV-VND7004AY | VND7004AY Evaluation Board |

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For further information contact your local STMicroelectronics sales office.

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1 Overview

The board comes pre-assembled with VND7004AY high-side driver. On board, a minimum set of electrical components (as for device datasheet recommendation), is enabling the user to directly connect the load, the power supply and the microcontroller without any additional effort in external component design and connection.

The VND7004AY is a double channel high-side driver manufactured using ST proprietary VIPower technology and housed in PowerSSO-36 packages. The device is designed to drive 12 V automotive grounded loads through a 3 V and 5 V CMOS-compatible interface, and to provide protection and diagnostics.

The device integrates also advanced protective functions such as load current limitation, overload active management by power limitation and overtemperature shutdown.

A FaultRST pin unlatches the output in case of fault or disables the latch-off functionality.

A dedicated multifunction multiplexed analog output pin delivers sophisticated diagnostic functions including high precision proportional load current sense, supply voltage feedback and chip temperature sense, in addition to the detection of overload and short circuit to ground, short to VCC and OFF-state open-load.

A sense enable pin allows OFF-state diagnosis to be disabled during the module low-power mode as well as external sense resistor sharing among similar devices.



Figure 1. EV-VND7004AY schematic



2 Board connections

Figure 2 shows the placement of the connectors to be used for supplying the evaluation board, connecting the load and controlling the functionality and diagnostic of the device.



Figure 2. Evaluation board connections

| Connector | Pin number | Pin name | Pin function |
|-----------|------------|--------------------|--|
| J3 | 14 | N/A | Not connected |
| J3 | 5 | IN_PullUP | Connection to optional external pull-up resistor for open load detection in off-state. |
| J3 | 6 | +5 V | 5 V Power Supply |
| J3 | 7 | FaultRST | Active low compatible with 3 V and 5 V CMOS outputs pin; it unlatches the output in case of fault; If kept low, sets the outputs in auto-restart mode. |
| J3 | 8 | MultiSense | Multiplexed analog sense output pin; it delivers a current proportional to the selected diagnostic: load current, supply voltage or chip temperature. |
| J3 | 9 | S_EN | Active high compatible with 3 V and 5 V CMOS outputs pin; it enables the MultiSense diagnostic pin. |
| J3 | 1011 | SEL _{0,1} | Active high compatible with 3 V and 5 V CMOS outputs pin; they address the MultiSense multiplexer. |
| J3 | 12 | N/A | Not connected |
| J3 | 1314 | IN _{0,1} | Voltage controlled input pin with hysteresis, compatible with 3 V and 5 V CMOS outputs. They control output switch state. |
| J3 | 1518 | N/A | Not connected |

Table 2. J3 connector: pin functions



In case the user wishes to utilize the Current Sense / MultiSense function of the device, it is necessary to plug a sense resistor in Rsense.

The package includes a through-hole resistor, to be mounted on TP1-TP2 - see Figure 4.

Different Rsense values can be adopted based on user preference.

Another option is soldering an SMD resistor on the dedicated PCB pad, as shown in *Figure 5*.



Figure 3. No sense resistor

Figure 4. Mounting through-hole sense resistor







Figure 5. Pads for soldering SMD resistor



3 Thermal data

| Table 3. | EV-VND7004AY | thermal data |
|----------|--------------|--------------|
|----------|--------------|--------------|

| Symbol | Parameter | Max | Unit |
|----------|---|-----|------|
| Rthj-amb | Thermal resistance junction-ambient (MAX) | 39° | °C/W |

Table 4. PCB specifications

| Parameter | Value |
|------------------------------|-----------------|
| Board dimensions | 25 mm x 41.5 mm |
| Number of Cu layer | 2 |
| Layer Cu thickness | 35 µm |
| Board finish thickness | 1.6 mm +/- 10% |
| Board Material | FR4 |
| Thermal vias diameter 0.5 mm | |



4 Revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 21-Oct-2016 | 1 | Initial release. |

